RES-XR5-3U

3U, 17 INCH DEPTH, 3-DRIVE, FRONT IO



STANDARD DENSITY RACK MOUNTED SERVER DATA SHEET



INDUSTRY-LEADING PERFORMANCE, ENHANCED RELIABILITY AND SUPERIOR RESILIENCE TO SHOCK, VIBRATION, AND TEMPERATURE EXTREMES

Featuring up to two E5-2600 v3/v4 Series Intel® Xeon® processors with up to twenty cores per socket, 1 TB DDR4 ECC memory, and enhanced reliability features, the Themis RES-XR5-3U server provides industry-leading performance and superior resilience to shock, vibration, and temperature extremes.

Designed for military, industrial, or rugged commercial use, the RES-XR5-3U server keeps mission-critical applications available in demanding environments where Size, Weight, and Power (SWAP) is an important consideration.

CONFIGURATION FLEXIBILITY

The RES-XR5-3U server provides configuration versatility and system expansion to meet your current and future system requirements. RES-XR5-3U servers can be mounted in standard commercial racks or mobile rugged transit cases.

THEMIS VALUE

Themis provides systems integrators and end-users with the best-of-breed computing resources available, and works closely with them to optimize computing solutions that are easy to integrate, yet inexpensive to own and operate. For the most current information on Themis products, visit www.themis.com.

PROCESSOR AND CPU

- ▶ Up to two E5-2600 v3/v4 Series Intel® Xeon® processors with up to twenty cores per socket
- ▶ Up to 1 TB DDR4 ECC

▶ Up to six PCle 3.0 cards

MANAGEMENT AND OPERATING SYSTEM

- ▶ Windows® and Linux® application support
- ▶ IPMI v2.0 support

ENVIRONMENTAL RESILIENCY

- ▶ Operating temperature range: 0°C to 50°C
- ▶ Extended temperature range: -15°C 65°C **
- Departing shock: 3 axis, 35g, 25ms
- Operating vibration: 4.76 Grms, 5Hz to 2000Hz (SSD)
- ▶ Operating humidity: 8% to 95% non-condensing*
- ▶ MIL-STD-810G, MIL-STD-901D, MIL-STD-167-1*
- ▶ MIL-STD-461 options available

MECHANICAL

- ▶ Height: 3U or 5.25 inches (133.35 mm)
- Width: 17 inches (432 mm)
- ▶ Depth: 17 inches (432 mm)
- ▶ Weight (typical*): 29 pounds (13.1 kg)

MODULAR MAINTAINABILITY

- ▶ Removable fans (3)
- Power supply options
 - Single or redundant 110/220 VAC (50/60Hz, 400Hz)
 - Single or redundant 18-36 VDC, 32 Amp
 - Single or redundant 36-72 VDC, 18 Amp
- ▶ Removable disk drives (3)
- * Themis designs all products to meet or exceed listed data sheet specifications. Some specifications are configuration dependent.
 ** Extended temperature range is dependent on system configuration, components, and
- application thermal profile. Please contact Themis for information specific to your desired configuration requirements









PROCESSOR AND CPU				
PARAMETER	DESCRIPTION			
Processor	Up to two E5-2600 v3/v4 Series Intel® Xeon® processors with up to twenty cores per socket			
Memory	Up to 1 TB DDR4 ECC			
ON-BOARD EXPANSION				
PARAMETER	QUANTITY DESCRIPTION			
Expansion Slots	6 Up to six PCle 3.0 cards			
FRONT AND REAR PANEL I/O ACCESS				
I/O	QUANTITY		ACCESS	
Removable 2.5 SATA or SAS disk drives	3		Front panel	
CD-RW/DVD-RW drive	1		Front panel	
Status LEDs	7		Front panel	
Gigabit Ethernet ports (RJ45)	2		Front panel	
USB 3.0 ports	4 standard vertical I/O or 2 standard horizontal I/O		Front panel	
IPMI 2.0 port	1		Front panel	
Power connector	1 or 2		Front panel	
Power switch	1		Front panel	
VGA graphics	1		Front panel	
ENVIRONMENTAL, NOTE 1				
PARAMETER	NON-OPERATING		OPERATING	
Temperature range	-40°C to 70°C		0°C to 50°C	
Extended temperature range	-40°C to 70°C		-15°C – 65°C, Note 2	
Humidity (non-condensing	5% to 95%		8% to 95%	
Shock	3 axis, 35g at 25 ms		3 axis, 35g at 25 ms	
Vibration (10-2000 Hz)	4.76 Grms, 5Hz to 2000Hz (SSD)		4.76 Grms, 5Hz to 2000Hz (SSD)	
MECHANICAL				
PARAMETER	DESCRIPTION			
Dimensions	Height: 3U or 5.25 inches (133.35 mm) Width: 17 inches (432 mm) Depth: 17 inches (432 mm)			
Weight (typical), Note 3	29 lbs (13.1 kg)			
Chassis features	Coated aluminum for light weight and corrosion resistance, stainless steel in selected areas to add strength and stiffness, modular design for easy upgrade and service, optional rack-mount slides and shock pins, and front to rear airflow			
MODULAR MAINTAINABILITY				
PARAMETER	DESCRIPTIO	DESCRIPTION		
Removable fans	3	3		
Weight (typical), Note 3	Single or redu	Single or redundant 110/220 VAC (50/60Hz, 400Hz) Single or redundant 18-36 VDC, 32 Amp Single or redundant 36-72 VDC		
Hot pluggable disk drives	3			

Notes

- Themis designs all products to meet or exceed listed data sheet specifications. Some specifications are configuration dependent. I/O options are configuration dependent
 Extended temperature range is dependent on system configuration, components, and application thermal profile. Contact Themis for information specific to your desired configuration requirements.
 Weights are provided for typical configurations. Weight may vary depending on configuration. Contact your Themis sales representatives for more information.

Corporate Headquarters 47200 Bayside Parkway Fremont, CA 94538 Tel: 510-252-0870 Fax: 510-490-5529

European Sales Office 5 rue Irène Joliot-Curie 38320 Eybens, France Tel: +33.476.14.77.86 Fax: +33.476.14.77.89

More Information For any additional information, go to www.themis.com.

